

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant(s): Chung-Chen Wu, Ming-Tzu Chen
Assignee: Delta Electronics, Inc.
Title: Method for Packing Electronic Devices by Interconnecting Frame Body
and Frame Leads with Insulating Block and its Packing Structure
Serial No.: Unassigned Filing Date: Hicewith
Examiner: Unassigned Group Art Unit: Unassigned
Docket No.: AB-1088-1D US

COMMISSIONER FOR PATENTS
Alexandria, VA 22313-1450

POWER OF ATTORNEY BY ASSIGNEE OF ENTIRE INTEREST

Sir:

The above-identified assignee, hereby revokes all powers of attorney previously given and appoints the attorney(s) and/or agent(s) identified below to prosecute the above-identified application and to transact all business in the United States Patent and Trademark Office in connection therewith:

Customer No. 32605

Please address all correspondence and telephone calls regarding this application to:

Theodore P. Lopez
MacPherson Kwok Chen & Heid LLP
1762 Technology Drive, Suite 226
San Jose, CA 95110
Phone: (949) 752-7040
Fax: (408) 392-9262

ASSIGNEE CERTIFICATION UNDER 37 CFR 3.73(B)

The undersigned representative of the above-identified assignee certifies that the above-identified assignee is the assignee of the entire right, title and interest in the above-identified

patent application/patent by virtue of a chain of title from the inventor(s) of the above-identified patent application/patent to the above-identified assignee as shown below.

1. From: Chung-Chen Wu To: Delta Electronics, Inc.
2. From: Ming-Tzu Chen To: Delta Electronics, Inc.

☐ The document was recorded in the United States Patent and Trademark Office at Reel 011409 Frame 0165. A copy of the document is attached.

The undersigned (whose title is supplied below) is empowered to sign this certificate on behalf of the above-identified assignee.

Date: NOV. 12, 2003

By: Raymond Hsu
(Signature)

Name: Raymond Hsu
(Printed or Typed Name)

Title: VP & General Manager
Components B. G.



APB-1088
UNITED STATES DEPARTMENT OF COMMERCE
Patent and Trademark Office

ASSISTANT SECRETARY AND COMMISSIONER
OF PATENTS AND TRADEMARKS
Washington, D.C. 20231

MARCH 21, 2001

SKJERVEN MORRILL MACPHERSON LLP
ALAN H. MACPHERSON
25 METRO DRIVE, SUITE 700
SAN JOSE, CA 95110

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MAR 27 2001

SKJERVEN, MORRILL, MACPHERSON,
LLP

UNITED STATES PATENT AND TRADEMARK OFFICE
NOTICE OF RECORDATION OF ASSIGNMENT DOCUMENT

THE ENCLOSED DOCUMENT HAS BEEN RECORDED BY THE ASSIGNMENT DIVISION OF THE U.S. PATENT AND TRADEMARK OFFICE. A COMPLETE MICROFILM COPY IS AVAILABLE AT THE ASSIGNMENT SEARCH ROOM ON THE REEL AND FRAME NUMBER REFERENCED BELOW.

PLEASE REVIEW ALL INFORMATION CONTAINED ON THIS NOTICE. THE INFORMATION CONTAINED ON THIS RECORDATION NOTICE REFLECTS THE DATA PRESENT IN THE PATENT AND TRADEMARK ASSIGNMENT SYSTEM. IF YOU SHOULD FIND ANY ERRORS OR HAVE QUESTIONS CONCERNING THIS NOTICE, YOU MAY CONTACT THE EMPLOYEE WHOSE NAME APPEARS ON THIS NOTICE AT 703-308-9723. PLEASE SEND REQUEST FOR CORRECTION TO: U.S. PATENT AND TRADEMARK OFFICE, ASSIGNMENT DIVISION, BOX ASSIGNMENTS, CG-4, 1213 JEFFERSON DAVIS HWY, SUITE 320, WASHINGTON, D.C. 20231.

RECORDATION DATE: 12/19/2000

REEL/FRAME: 011409/0165
NUMBER OF PAGES: 2

BRIEF: ASSIGNMENT OF ASSIGNOR'S INTEREST (SEE DOCUMENT FOR DETAILS).

ASSIGNOR:
WU, CHUNG-CHEN

DOC DATE: 12/08/2000

ASSIGNOR:
CHEN, MING-TZU

DOC DATE: 12/08/2000

ASSIGNEE:
DELTA ELECTRONICS, INC.
NO. 31-1, SHIEN PAN RD., KUEI SAN
INDUSTRIAL ZONE
TAOYUAN HSIEN, TAIWAN R.O.C.

SERIAL NUMBER: 09741239
PATENT NUMBER:

FILING DATE: 12/19/2000
ISSUE DATE:

ATTORNEY: AHM

KIMBERLY WHITE, EXAMINER
ASSIGNMENT DIVISION
OFFICE OF PUBLIC RECORDS

ACTION: IDS DUE: 3/19/01
ACTION: Status DUE: 12/19/02
ACTION: _____ DUE: _____
DOCKETED BY: RD DATE: 4/12/01
FORM LETTER: YES/NO

01-12-2001

ATTORNEY DOCKET NO.: AB-1088 US

U.S. DEPARTMENT OF COMMERCE
PATENT AND TRADEMARK OFFICE

JET



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12/19/00

TO THE HONORABLE DIRECTOR OF THE UNITED STATES PATENT AND TRADEMARK OFFICE. PLEASE RECORD THE ATTACHED ORIGINAL DOCUMENTS OR COPY THEREOF.

1. Name of conveying party(ies):

- (a) WU, Chung-Chen
-
- (b) CHEN, Ming-Tzu

Additional name(s) of conveying party(ies) attached?

☐ Yes☒ No

2. Name and address of receiving party(ies):

Name: Delta Electronics, Inc.

Address: No. 31-1, Shien Pan Rd., Kuei San Industrial Zone,
Taoyuan Hsien, Taiwan, R.O.C.

3. Nature of Conveyance:

- ☒
- Assignment
- ☐
- Merger
-
- ☐
- Security Agreement
- ☐
- Change of Name
-
- ☐
- Other _____

Execution Date: December 8, 2000

Name and address of receiving party(ies):

Name:

Address:

Additional name(s) & address(es) attached?

☐ Yes☒ No

4. Application number(s) or patent number(s):

If this document is being filed together with a new application, the execution date of the application is: December 8, 2000

A. Patent Application No.(s) -

Title: Method For Packing Electronic Device By
Interconnecting Frame Body And Frame Leads With Insulating Block
And Its Packing Structure

B. Patent No.(s)

Additional numbers attached?



Yes



No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: Alan H. MacPherson

Internal Address: SKJERVEN MORRILL MacPHERSON LLP

Street Address: 25 METRO DRIVE, SUITE 700

City SAN JOSE State CA Zip 95110

6. Total number of applications and patents involved: 1

7. Total fee (37 CFR 3.41): \$40.00

- ☒
- Authorized to be charged to Deposit Account 19-2386
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- Charge Deposit Account 19-2386 for any additional fees required for this conveyance and credit deposit account 19-2386 any amounts overpaid

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8. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Alan H. MacPherson 24,423
Name of Person Signing

Signature

Date

Total number of pages comprising cover sheet: 2

ASSIGNMENT

In consideration of good and valuable consideration, the receipt of which is hereby acknowledged, the undersigned,

(1) Chung-Chen Wu, Ming-Tzu Chen

HEREBY SELL(S), ASSIGN(S) AND TRANSFER(S) TO

(2) Delta Electronics, Inc. having a place of business at

(3) No. 31-1, Shien Pan Rd., Kuei San Industrial Zone, Taoyuan Hsien, Taiwan, R.O.C.

(hereinafter called "ASSIGNEE") the entire right, title and interest in and to any and all improvements which are disclosed in the application for United States Letters Patent entitled

(4) METHOD FOR PACKING ELECTRONIC DEVICE BY INTERCONNECTING FRAME BODY AND FRAME LEADS WITH INSULATING BLOCK AND ITS PACKING STRUCTURE

which application was:

(a) executed by the undersigned on (5a) DECEMBER 8, 2000

(b) filed on (5b) _____

and assigned Serial No. _____

including any and all United States Letters Patents which may be granted on said application, and any and all extensions, divisions, reissues, substitutes, renewals or continuations of said application and patents, and the right to all benefits under all international conventions for the protection of industrial property and applications for said improvements.

It is hereby authorized and requested that the Commissioner of Patents issue any and all of said Letters Patent, when granted, to said Assignee, its assigns or its successors in interest or its designee.

Upon said consideration, it is further agreed that, when requested, without charge to but at the expense of said Assignee, the undersigned will execute all divisional, continuing, substitute, renewal, and reissue patent applications; execute all rightful other papers; and generally do everything possible which said Assignee shall consider desirable for aiding in securing and maintaining patent protection as provided herein.

DATE:

DECEMBER 8, 2000

DECEMBER 8, 2000

INVENTOR(S)

Chung-Chen Wu
Ming-Tzu Chen

WITNESSES:

Declaration and Power of Attorney For Patent Application

English Language Declaration

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name,

I verily believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled

METHOD FOR PACKING ELECTRONIC DEVICE BY INTERCONNECTING FRAME BODY AND FRAME LEADS WITH INSULATING BLOCK AND ITS PACKING STRUCTURE

the specification of which

(check one)

☒ is attached hereto.

☐ was filed on _____ as

Application Serial No. _____

and was amended on _____

(if applicable)

I hereby state that I have reviewed and understand the contents of the above identified specification, including the claims, as amended by any amendment referred to above.

I acknowledge the duty to disclose to the Office all information known to me to be material to the patentability of this application in accordance with Title 37, Code of Federal Regulations, § 1.56(a).

I hereby claim foreign priority benefits under Title 35, United States Code, § 119 of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application on which priority is claimed:

Prior Foreign Application(s)

<u>89115354</u>	<u>Taiwan</u>	<u>31/July/2000</u>
(Number)	(Country)	(Day/Month/Year Filed)

_____	_____	_____
(Number)	(Country)	(Day/Month/Year Filed)

_____	_____	_____
(Number)	(Country)	(Day/Month/Year Filed)

Priority Claimed

<input checked="" type="checkbox"/>	<input type="checkbox"/>
Yes	No
<input type="checkbox"/>	<input type="checkbox"/>
Yes	No
<input type="checkbox"/>	<input type="checkbox"/>
Yes	No

I hereby claim the benefit under Title 35, United States Code, § 120 any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of title 35, United States Code, § 112, I acknowledge the duty to disclose to the Office all information known to me to be material to patentability of the application as defined in Title 37, Code of Federal Regulations, § 1.56(a) which occurred between the filing date of the prior application and the national or PCT international filing date of this application:

(Application Serial No.)

(Filing Date)

(Status)
(patented, pending, abandoned)

(Application Serial No.)

(Filing Date)

(Status)
(patented, pending, abandoned)

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

POWER OF ATTORNEY: As a named inventor, I hereby appoint the following attorney(s) and/or agent(s) to prosecute this application and transact all business in the Patent and Trademark Office connected therewith.

See Attachment

Send Correspondence to SKJERVEN MORRILL MACPHERSON LLP
25 Metro Drive, Suite 700, San Jose, California, U.S.A.

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at telephone No. (408) 453-9200

Full name of sole or first inventor Chung-Chen Wu	
Inventor's signature <i>Chung-Chen Wu</i>	Date DECEMBER 8, 2000
Residence No.31-1, Shien Pan Rd., Kuei San Industrial Zone, Taoyuan Hsien, Taiwan, R.O.C.	
Citizenship A citizen of Taiwan, R.O.C.	
Post Office Address The same as above	
Full name of second joint inventor, if any Ming-Tzu Chen	
Second Inventor's signature <i>Ming-Tzu Chen</i>	Date DECEMBER 8, 2000
Residence No.31-1, Shien Pan Rd., Kuei San Industrial Zone, Taoyuan Hsien, Taiwan, R.O.C.	
Citizenship A citizen of Taiwan, R.O.C.	
Post Office Address The same as above	

(Supply similar Information and signature for third and subsequent joint inventors.)

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